

Electronic Patent Application Fee Transmittal

Application Number:	10750834			
Filing Date:	05-Jan-2004			
Title of Invention:	HIGH DENSITY METAL CAPACITOR USING VIA ETCH STOPPING LAYER AS FIELD DIELECTRIC IN DUAL-DAMASCENCE INTERCONNECT PROCESS			
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Filer:	Jason Daniel Eisenberg			
Attorney Docket Number:	1875.0230001			
Filed as Large Entity				
Utility Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Certificate of correction	1811	1	100	100
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				100